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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re patent application of
Hongtao Han et al.

Group Art Unit: 2818

Serial No.: 10/087,989

Examiner: David VU

Filed: March 5, 2002

For: Thick Wafer Processing and Resultant Structure

Assistant Commissioner of Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Date: February 3, 2004

AMENDMENT

Sir:

In response to the Office Action dated September 3, 2003, the period for response having been extended two (2) months to February 3, 2004, the following amendments and remarks are respectfully submitted in connection with the above-identified application.

Amendments to the Claims begin on page 2 of this paper.

Remarks/Arguments begin on page 5 of this paper.